

ECN #	APPRVD.	DATE
1	MAC	8-19-98

SAFETY ORGANIZATIONS

THIS JACK HAS BEEN FORMALLY RECOGNIZED, CERTIFIED OR APPROVED BY THE LISTED AGENCY. THEREFORE, ALL TEST/REQUIREMENTS SPECIFIED IN THE LATEST REVISION OF THE FOLLOWING AGENCY STANDARDS HAVE BEEN MET.

UL RECOGNIZED
CSA CERTIFIED

UL 1863
CSA C22.2 No. 182.4

SPECIFICATIONS

CONTACTS

MATERIAL: PHOSPHOR BRONZE
 PLATING: 50 MICRONS GOLD
 BARRIER UNDERPLATING: 100 MICRONS NICKEL
 RESISTANCE:
 INITIAL: 20 MILLIOHMS MAXIMUM
 AFTER DURABILITY TESTING (500 MATING CYCLES): 30 MILLIOHMS MAXIMUM

FERRITES

TYPE: HIGH RESISTIVITY, NICKEL ZINC CERAMIC
 BLOCK: MULTI-TEMPERATURE RECTANGULAR PRISM

SHIELD MATERIAL

N/A

HOUSING MATERIAL

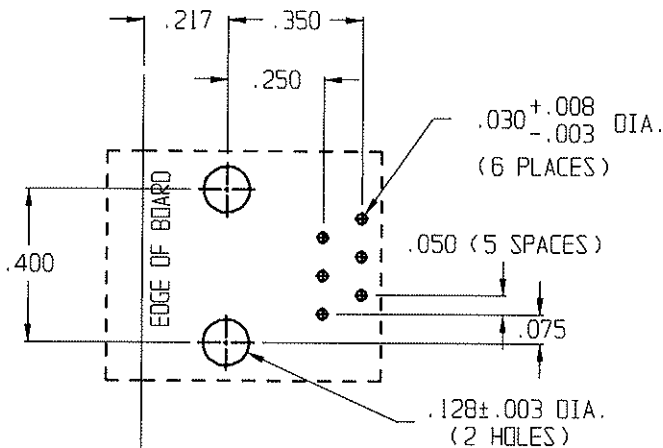
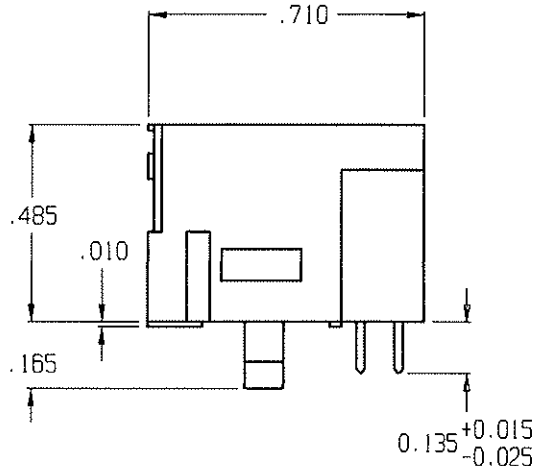
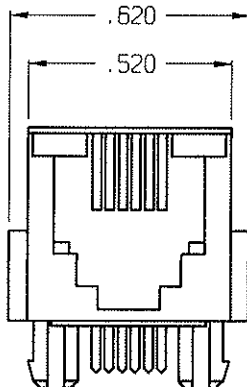
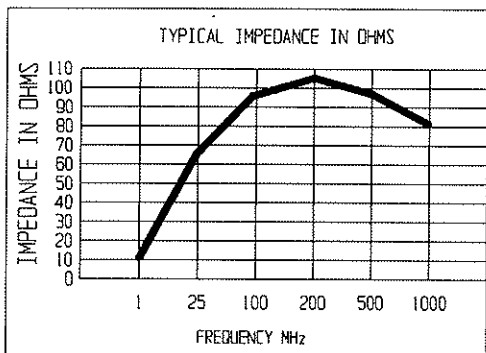
GLASS-FILLED POLYESTER (UL94V-0)

DIELECTRIC WITHSTANDING VOLTAGE

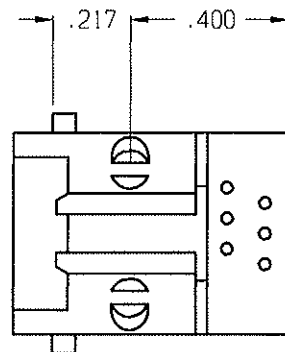
LINE-TO-LINE AND LINE-TO-GROUND 1000 VAC FOR 60 SECONDS

PRINTED CIRCUIT BOARD RETENTION

BEFORE SOLDERING: 1 LB. MINIMUM
 AFTER SOLDERING: 20 LB. MINIMUM



PC BOARD LAYOUT



COMPLIES WITH FCC PART 68

THIRD ANGLE PROJECTION			
UNLESS OTHERWISE SPECIFIED, TOLERANCE TO BE ± .010 MATERIAL & FINISH: AS SUPPLIED		844 E. ROCKLAND RD. LIBERTYVILLE IL 60048	
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CAD FILE: G:\CDNRJ116N800	SCALE: NTS	DATE: 8-14-98	CATALOG NO. RJ11-6N-B
DRW. BY: SD	DRG: MAC	REV. 00	

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